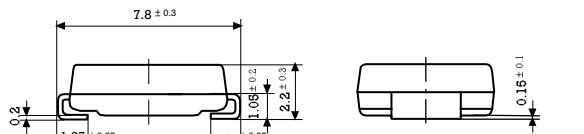
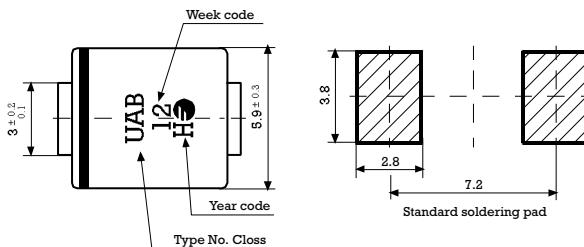


### 3 Amp. Surface Mounted Glass Passivated Rectifier

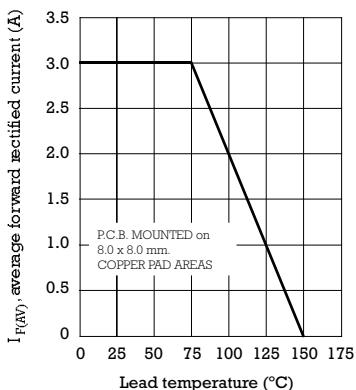
Dimensions in mm.	CASE: SMC/DO-214AB	Voltage 50 to 1000 V	Current 3.0 A
 			
<ul style="list-style-type: none"> <li>• Glass passivated junction</li> <li>• High current capability</li> <li>• The plastic material carries U/L 94 V-0</li> <li>• Low profile package</li> <li>• Easy pick and place</li> <li>• High temperature soldering 260 °C 10 sec</li> </ul>			<b>MECHANICAL DATA</b> Terminals: Solder plated, solderable per IEC 68-2-20. Standard Packaging: 8 mm. tape (EIA-RS-481). Weight: 1.12 g.

### Maximum Ratings and Electrical Characteristics at 25 °C

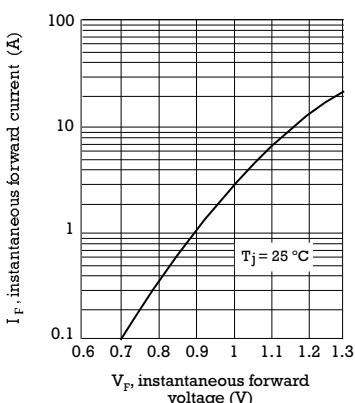
		FS3A	FS3B	FS3D	FS3G	FS3J	FS3K	FS3M
	Marking Code	T1	T2	T3	T4	T5	T6	T7
V <sub>RPM</sub>	Maximum Recurrent Peak Reverse Voltage	50	100	200	400	600	800	1000
V <sub>RMS</sub>	Maximum RMS Voltage	35	70	140	280	420	560	700
V <sub>DC</sub>	Maximum DC Blocking Voltage	50	100	200	400	600	800	1000
I <sub>F(AV)</sub>	Forward current at T <sub>L</sub> = 75 °C	3 A						
I <sub>FSM</sub>	8.3 ms. peak forward surge current (Jedec Method)	100 A						
V <sub>F</sub>	Maximum Instantaneous Forward Voltage at 3 A	1.15 V						
I <sub>R</sub>	Maximum DC Reverse Current Ta = 25 °C at Rated DC Blocking Voltage Ta = 125 °C	10 µA 250 µA						
C <sub>j</sub>	Typical Junction Capacitance (1MHz; -4V)	60 pF						
R <sub>th (j-l)</sub> R <sub>th (j-a)</sub>	Typical Thermal Resistance (5x5 mm <sup>2</sup> x 130 µ Copper Area)	13 °C/W 47 °C/W						
T <sub>j</sub> - T <sub>stg</sub>	Operating Junction and Storage Temperature Range	-55 to + 150 °C						

## Rating And Characteristic Curves

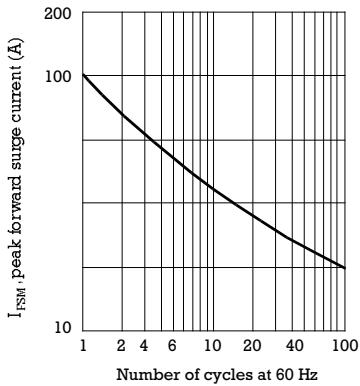
FORWARD CURRENT DERATING CURVE



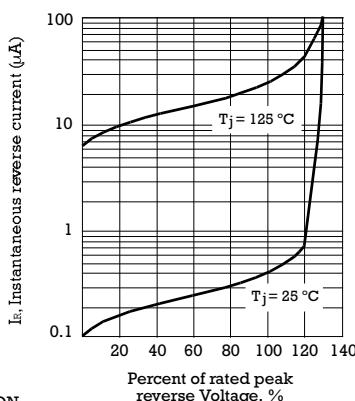
TYPICAL FORWARD CHARACTERISTIC



MAXIMUM NON REPETITIVE PEAK FORWARD SURGE CURRENT



TYPICAL REVERSE CHARACTERISTIC



TYPICAL JUNCTION CAPACITANCE

